



## 22N20

Preliminary

Power MOSFET

### 22A, 200V N-CHANNEL POWER MOSFET

#### DESCRIPTION

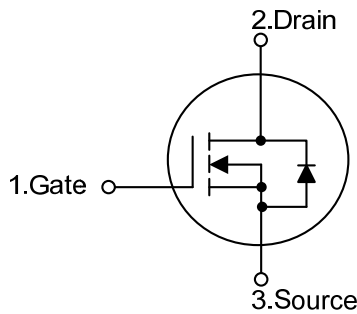
The UTC **22N20** is an N-channel enhancement mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology is specialized in allowing a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC **22N20** is universally applied in low voltage such as automotive, high efficiency switching for DC/DC converters and DC motor control.

#### FEATURES

- \* Fast switching
- \*  $R_{DS(on)} < 0.14\Omega @ V_{GS} = 10V, I_D = 11A$
- \* Typically 20nC low gate charge
- \* 100% avalanche tested
- \* Typically 25pF Low  $C_{RSS}$
- \* Improved dv/dt capability

#### SYMBOL

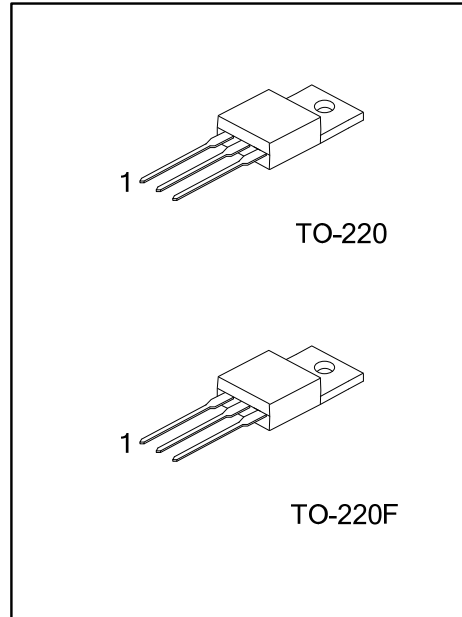


#### ORDERING INFORMATION

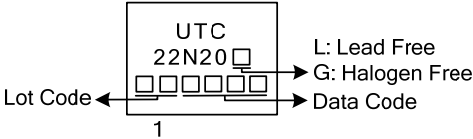
Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
22N20L-TA3-T	22N20G-TA3-T	TO-220	G	D	S	Tube
22N20L-TF3-T	22N20G-TF3-T	TO-220F	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>22N20L-TA3-T</p> <p>(1) Packing Type (2) Package Type (3) Green Package</p>	<p>(1) R: Tape Reel (2) TA3: TO-220, TF3: TO-220F (3) L: Lead Free, G: Halogen Free and Lead Free</p>
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MARKING



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■ ABSOLUTE MAXIMUM RATINGS ( $T_C=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	200	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Drain Current	Continuous ( $T_C=25^\circ\text{C}$ )	$I_D$	22	A
	Pulsed (Note 2)	$I_{DM}$	88	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	250	mJ
Power Dissipation ( $T_C=25^\circ\text{C}$ )	TO-220	$P_D$	156	W
	TO-220F		50	
Derate above $25^\circ\text{C}$	TO-220		1.25	W/ $^\circ\text{C}$
	TO-220F		0.4	
Junction Temperature		$T_J$	+150	$^\circ\text{C}$
Storage Temperature		$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3.  $L = 0.85\text{mH}$ ,  $I_{AS} = 21\text{A}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient		$\theta_{JA}$	62.5	$^\circ\text{C/W}$
Junction to Case	TO-220	$\theta_{JC}$	0.8	$^\circ\text{C/W}$
	TO-220F		2.5	

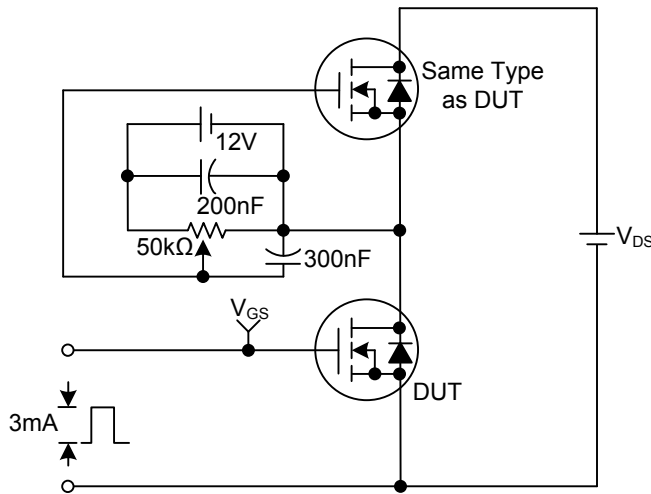
■ ELECTRICAL CHARACTERISTICS ( $T_C=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$I_D=250\mu\text{A}$ , $V_{GS}=0\text{V}$	200			V
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	Reference to $25^\circ\text{C}$ , $I_D=250\mu\text{A}$		0.25		$\text{V}/^\circ\text{C}$
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=200\text{V}$ , $V_{GS}=0\text{V}$			1	$\mu\text{A}$
		$V_{DS}=160\text{V}$ , $T_C=125^\circ\text{C}$			10	
Gate- Source Leakage Current	Forward	$V_{GS}=+30\text{V}$ , $V_{DS}=0\text{V}$			+100	nA
	Reverse	$V_{GS}=-30\text{V}$ , $V_{DS}=0\text{V}$			-100	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_D=250\mu\text{A}$	2.0		4.0	V
Static Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10\text{V}$ , $I_D=11\text{A}$		0.12	0.14	$\Omega$
<b>DYNAMIC PARAMETERS</b>						
Input Capacitance	$C_{ISS}$	$V_{GS}=0\text{V}$ , $V_{DS}=25\text{V}$ , $f=1.0\text{MHz}$		1700	2200	pF
Output Capacitance	$C_{OSS}$			220	290	pF
Reverse Transfer Capacitance	$C_{RSS}$			30	40	pF
<b>SWITCHING PARAMETERS</b>						
Total Gate Charge	$Q_G$	$V_{GS}=10\text{V}$ , $V_{DS}=160\text{V}$ , $I_D=22\text{A}$ (Note 1, 2)		27	35	nC
Gate to Source Charge	$Q_{GS}$			5.8		nC
Gate to Drain Charge	$Q_{GD}$			11.2		nC
Turn-ON Delay Time	$t_{D(ON)}$	$V_{DD}=100\text{V}$ , $I_D=22\text{A}$ , $R_G=25\Omega$ (Note 1, 2)		35	80	ns
Rise Time	$t_R$			300	610	ns
Turn-OFF Delay Time	$t_{D(OFF)}$			130	270	ns
Fall-Time	$t_F$			180	370	ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Body-Diode Continuous Current	$I_S$				22	A
Maximum Body-Diode Pulsed Current	$I_{SM}$				88	A
Drain-Source Diode Forward Voltage	$V_{SD}$	$I_S=22\text{A}$ , $V_{GS}=0\text{V}$			1.5	V

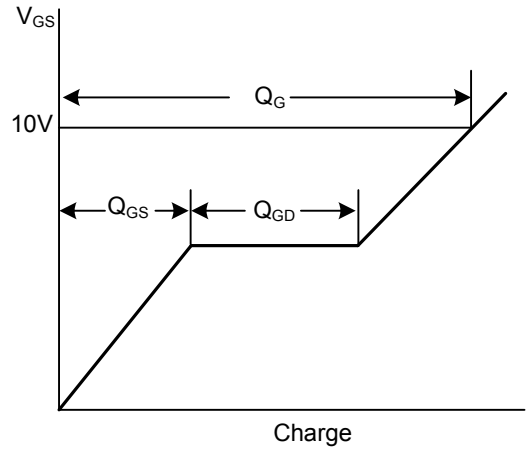
Notes: 1. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$ .  
2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

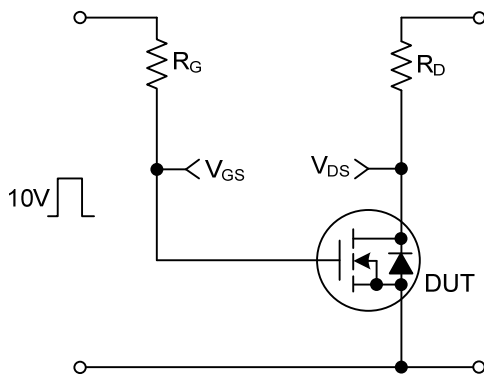
Gate Charge Test Circuit



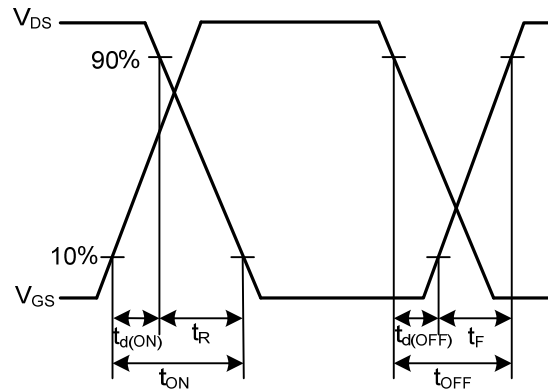
Gate Charge Waveforms



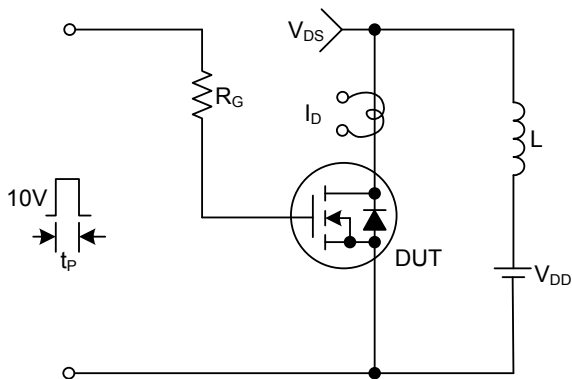
Resistive Switching Test Circuit



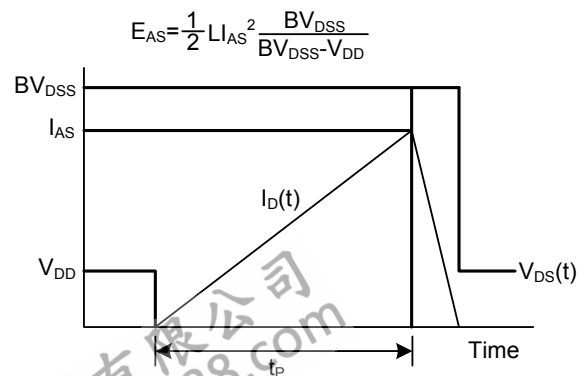
Resistive Switching Waveforms



Unclamped Inductive Switching Test Circuit

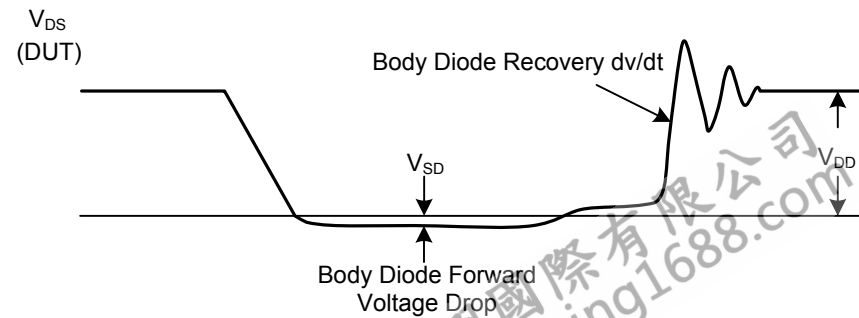
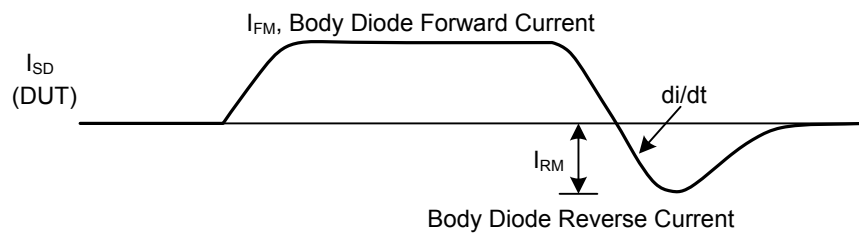
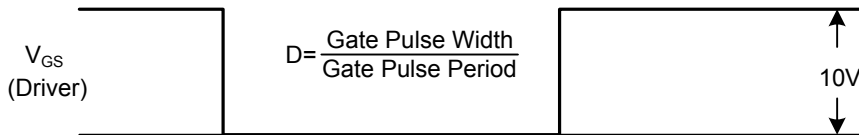
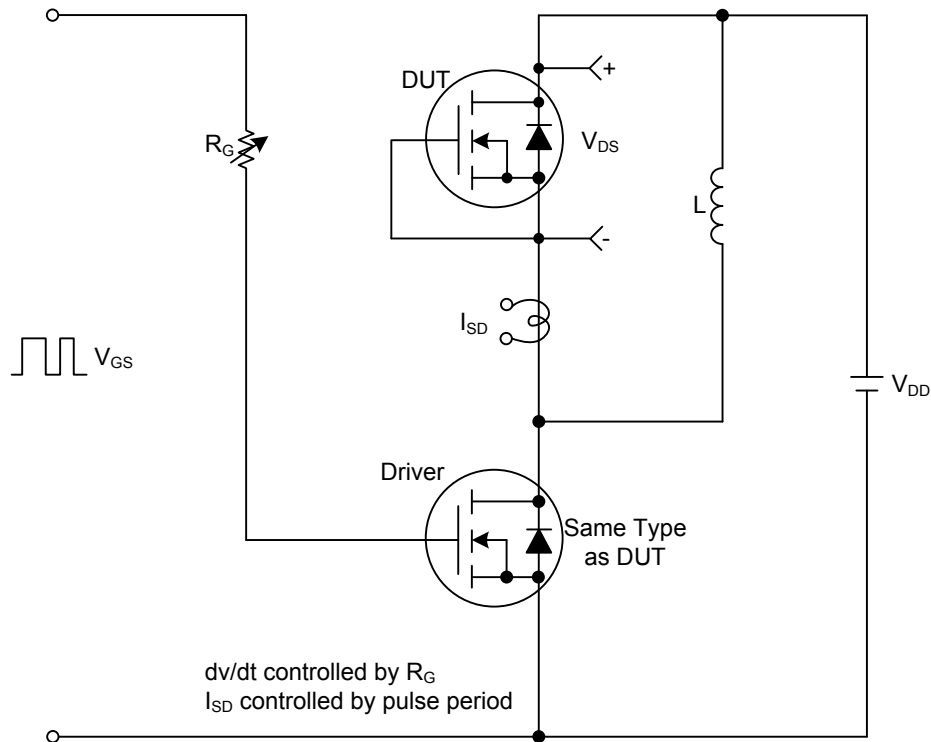


Unclamped Inductive Switching Waveforms



■ TEST CIRCUITS AND WAVEFORMS (Cont.)

Peak Diode Recovery dv/dt Test Circuit & Waveforms



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